Vishay Techno

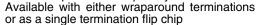


Thick Film Chip Resistors, High Voltage



FEATURES

- High voltage up to 3000 V
- Outstanding stability < 0.5 %
- Flow solderable
- Custom sizes available
- Automatic placement capability



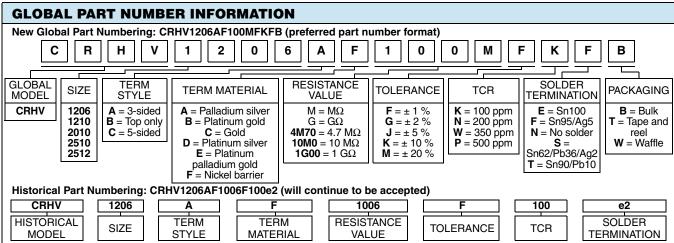


- · Tape and reel packaging available
- Internationally standardized sizes
- Suitable for solderable, epoxy bondable, or wire bondable applications
- Termination: Gold, palladium silver, platinum gold, platinum silver, platinum palladium gold or solder-coated nickel barrier available
- Multiple styles, termination materials and configurations, allow wide design flexibility
- Non-magnetic terminations available
- Compliant to RoHS directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition

STANDARD ELECTRICAL SPECIFICATIONS							
GLOBAL MODEL	POWER RATING P _{70°C} W	RESISTANCE RANGE (1) Ω	TOLERANCE (2) ± %	TEMPERATURE COEFFICIENT ⁽³⁾ (- 55 °C to + 150 °C) ± ppm/°C	MAXIMUM WORKING VOLTAGE ⁽⁴⁾ V		
CRHV1206	0.30	2M to 1G	1, 2, 5, 10, 20	100	1500		
		1.1G to 8G	2, 5, 10, 20				
CRHV1210	0.45	4M to 1G	1, 2, 5, 10, 20	100	1750		
	0.43	1.1G to 10G	2, 5, 10, 20				
CRHV2010		6M to 1G	1, 2, 5, 10, 20	100	2000		
	0.50	1.1G to 10G	2, 5, 10, 20				
		11G to 35G	5, 10, 20				
CRHV2510		10M to 1G	1, 2, 5, 10, 20		2500		
	0.60	1.1G to 10G	2, 5, 10, 20	100			
		11G to 40G	5, 10, 20				
CRHV2512		12M to 1G	1, 2, 5, 10, 20	100	3000		
	0.70	1.1G to 10G	2, 5, 10, 20				
		11G to 50G	5, 10, 20	1			

Notes

- For non-standard sizes, lower values or higher power rating requirement, contact factory
- (1) Resistance values are calibrated at 100 V_{DC}. Calibration at other voltages available upon request.
- (2) Contact factory for tighter tolerances
- (3) Reference only: Not for all values specified. Consult factory for your size and value
- (4) Continuous working voltage shall be $\sqrt{P \times R}$ or maximum working voltage, whichever is less



Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 68002 Revision: 17-Feb-10



Thick Film Chip Resistors, High Voltage

MECHANICAL SPECIFICATIONS						
Resistive Element	Ruthenium oxide					
Encapsulation	Glass					
Substrate	96 % alumina					
Termination	Solder-coated nickel barrier standard. Gold, palladium silver, platinum gold, platinum silver, platinum palladium gold terminations available.					
Solder Finish	Pure tin or tin/lead solder alloys standard Hot solder dipped tin/silver or tin/lead/silver solder alloys available.					

ENVIRONMENTAL SPECIFICATIONS

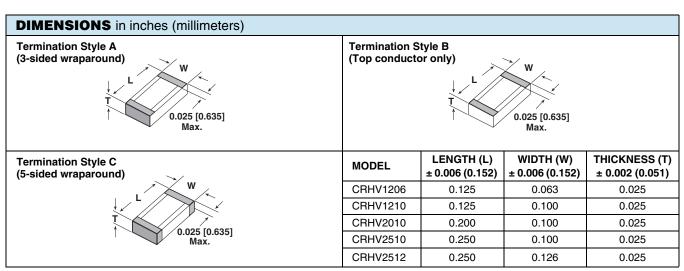
Operating Temperature: - 55 °C to + 150 °C

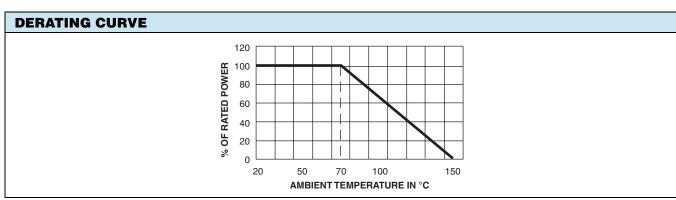
 $\mbox{\bf Life:}$ Less than 0.5 % change when tested at full rated power

Short Time Overload: Less than 0.5 % ΔR

(Reference only: Not for all values specified. Consult factory for your size and value.)

VOLTAGE COEFFICIENT OF RESISTANCE CHART						
SIZE	VALUE (Ω)	VCR (ppm/V)	FURTHER INSTRUCTIONS			
CRHV1206	2M to 199M	25	Values over 200M, consult factory			
CRHV1210	4M to 200M	25	Values over 200M, consult factory			
CRHV2010	6M to 99M	15	Values over 1G, consult factory			
CHHVZUIU	100M to 1G	20				
CRHV2510	10M to 99M	10	Values are 10 consult factors			
CHHV2510	100M to 1G	15	Values over 1G, consult factory			
CRHV2512	12M to 999M	10	Values aver EC consult factory			
CHUNSIS	1G to 5G	25	Values over 5G, consult factory			





(Reference only: Not for all values specified. Consult factory for your size and value.)

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CRHV

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TYPE	TERMINATION MATERIAL	TERMINATION STYLE	TERMINATION STYLE/ MATERIAL CODE	SOLDER TERMINATION CODE	
Solderable	Nickel barrier	3-sided (wraparound)	AF	E, F, S, or T ⁽³⁾	
		Top only (flip chip)	BF		
Wire bondable/ Solderable	Platinum palladium gold	3-sided (wraparound)	AE		
		Top only (flip chip)	BE	N, F or S ⁽¹⁾	
		5-sided (wraparound)	CE		
Wire bondable/ Epoxy bondable	Gold	3-sided (wraparound)	AC		
		Top only (flip chip)	BC	N	
		5-sided (wraparound)	CC		
Epoxy bondable	Palladium silver ⁽²⁾	3-sided (wraparound)	AA		
		Top only (flip chip)	BA		
		5-sided (wraparound)	CA		
	Platinum gold	3-sided (wraparound)	AB		
		Top only (flip chip)	BB	N	
		5-sided (wraparound)	СВ		
	Platinum silver	3-sided (wraparound)	AD		
		Top only (flip chip)	BD		
		5-sided (wraparound)	CD		

Notes

Document Number: 68002 Revision: 17-Feb-10

⁽¹⁾ Use solder termination N for applications requiring wire bondable mounting, and solder terminations F or S for applications requiring solderable mounting.

⁽²⁾ While not recommended, palladium silver terminations could be used for solderable applications when using a solder alloy containing silver.

⁽³⁾ Standard solder plating for the nickel barrier parts are solder terminations E or T. Hot solder dipped terminations F or S are also available.





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